

# Atomic layer deposition of HfO<sub>2</sub> thin film using a novel linked cyclopentadienyl-amido Hf precursor

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Hafnium oxide (HfO<sub>2</sub>) is presently considered as one of the most promising candidates for alternative gate oxide insulating layers in CMOS (complementary metal oxide semiconductor) devices because of its thermal stability, high permittivity, and relatively large bandgap. Other possible applications for HfO<sub>2</sub> thin film include DRAM (dynamic random access memory) capacitors and optical coatings. In this study, we introduce a novel linked cyclopentadienyl-amido Hf precursor, CMENHa. Also, we compared the properties of the HfO<sub>2</sub> thin film of CMENHa to those of CpHf(NMe<sub>2</sub>)<sub>3</sub> grown by atomic layer deposition (ALD).

The physical characteristics of CMENHa, CpHf(NMe<sub>2</sub>)<sub>3</sub> and Hf(NEtMe)<sub>4</sub> were investigated by NMR and viscometer. It was notable that the viscosity of CMENHa was similar to CpZr(NMe<sub>2</sub>)<sub>3</sub>. The thermal stability of CMENHa was also investigated by thermogravimetric analysis (TGA). The amount of residue was about 0.6% for CMENHa, which had a less residue compared to CpHf(NMe<sub>2</sub>)<sub>3</sub> (2.5%) and Hf(NEtMe)<sub>4</sub> (3.2%). The ALD characteristics of CMENHa compare to CpHf(NMe<sub>2</sub>)<sub>3</sub> will be discussed in the conference. Based on suitable viscosity and good thermal stability, the CMENHa is expected to be promising precursor for insulating layer in gate oxide and DRAM capacitors.

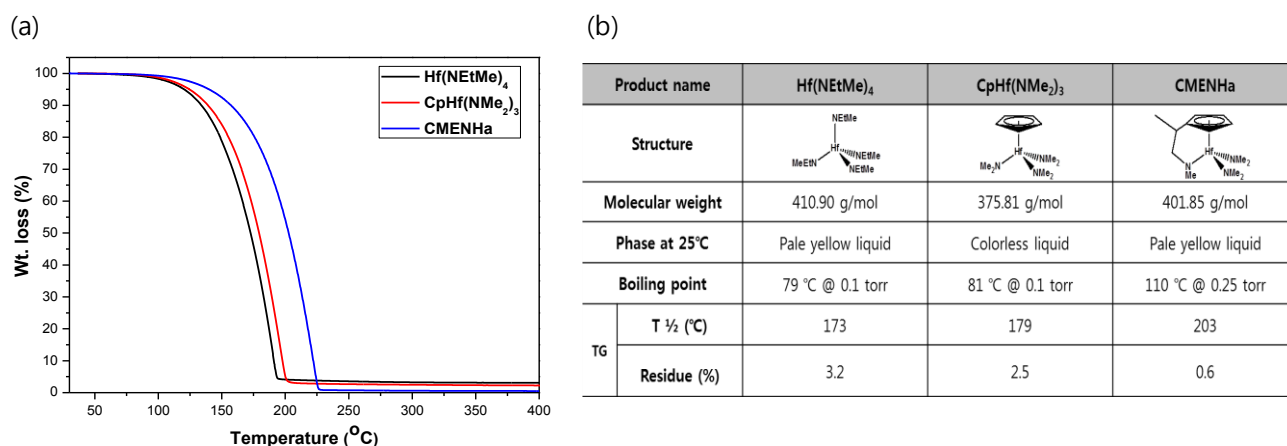


Figure 1. (a) Thermogravimetric analysis of Hf precursors, (b) Physical characteristics of Hf precursors